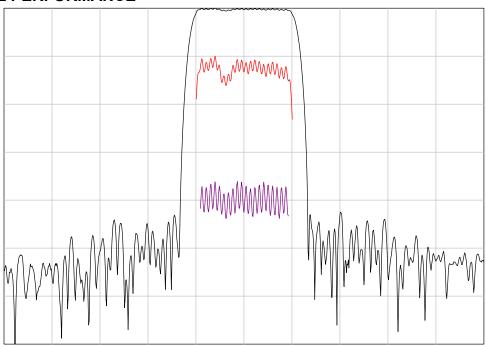


# **DESCRIPTION**

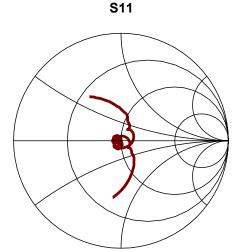
- 150 MHz SAW bandpass filter with 5.7 MHz bandwidth.
- 13.3 x 6.5 mm SMP.
- RoHS compliant.

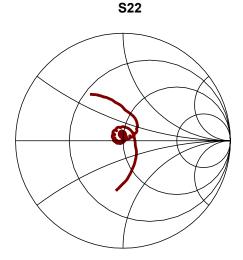
## **TYPICAL PERFORMANCE**



Horizontal: Vertical from Top:

Frequency: 2.5 MHz/div
Relative Magnitude: 10 dB/div
Relative magnitude: 1 dB/div
Group Delay Deviation: 150 ns/div







## **SPECIFICATION**

Parameter <sup>1</sup>	Min	Тур	Max	Units
Center Frequency (F <sub>C</sub> ) <sup>2</sup>	149.875	150.025	150.175	MHz
Insertion Loss <sup>4</sup>	-	19.3	21	dB
1 dB Bandwidth <sup>3</sup>	5.7	5.95	ı	MHz
3 dB Bandwidth 3	6.1	6.42	ı	dB
40 dB Bandwidth <sup>3</sup>	-	7.95	8.3	dB
Stopband Rejection (25 to 135 MHz)	45	54	-	dB
Stopband Rejection (165 to 2000 MHz)	45	53	-	dB
Passband Amplitude Variation (Fc+/-2.75 MHz)	-	0.67	0.8	dB p-p
Passband Group Delay Variation (Fc+/-2.75 MHz) 5	-	115	150	ns p-p
Absolute Delay	-	1.81	2.0	us
Input and Output Return Loss(Fc+/-2.75 MHz) 5	-	1.3	1.8	:1
Source and Load Impedance	-	50	-	Ω
Ambient Temperature	-	25	-	°C

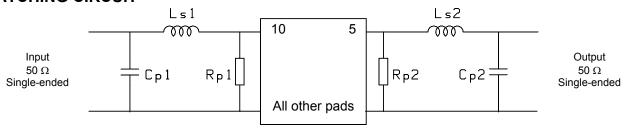
Notes:

- 1. All electrical specifications apply over the full operating temperature range and include allowance for all manufacturing tolerance.
- 2. Defined as the mean of the 10 dB frequencies.
- 3. dB levels are taken to be relative to the insertion loss.
- 4. Measured at the maximum level (lowest insertion loss) of the response.
- 5. When matched as indicated below.

## **MAXIMUM RATINGS**

Parameter	Min	Max	Units
Storage Temperature Range	-45	85	°C
Operating Temperature Range	-10	50	°C
Input Power Level	-	20	dBm
D.C. Voltage between Each Terminal	-	15	V
ESD Level	Human Body Model: 1000 V Machine Model: 200 V		

### **MATCHING CIRCUIT**



Typical component values:

(Minimum inductor Q = 40) 39 nΗ 33 nΗ 47 рF Cp1 = рF Cp2 = 50 Rp1 =220 Rp2 =130 Ω

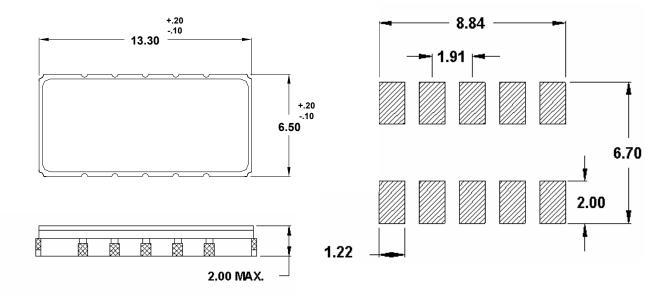
#### Notes:

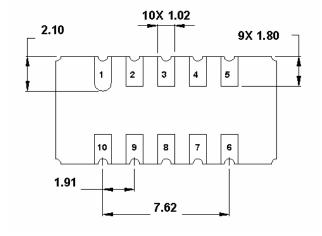
- 1. Required component tolerances: resistors +/-5%, inductors +/-2%, capacitors +/-5%
- 2. Component values shown are for guidance only and may change depending on board layout.



## **PACKAGE OUTLINE**

## SUGGESTED FOOTPRINT





Units: mm

Tolerances are  $\pm 0.15$  mm except for the overall length and width, which are nominal values.

# **Pad Configuration:**

Input: 10
Output: 5

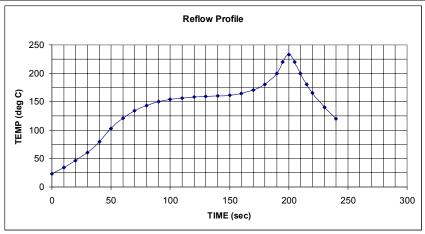
Ground: 1,2,3,4,6,7,8,9

Package Material: Body:  $Al_2O_3$  ceramic Lid: Kovar, Ni plated Terminations: Au plating 1 µm min, over a 1.3-8.9 µm Ni plating



## PHYSICAL AND ENVIRONMENTAL CHARACTERISTICS

Parameter	Qualification Conditions
Life Testing	High temperature bake at +85 °C for 168 hours.
Temperature Cycling	MIL-STD 883, Method 1010:
	-40 °C to +85 °C, 10 cycles, 10 minutes dwell at
	temperature extremes
	MIL-STD-202, Method 201A:
Vibration	10 to 55 Hz, double amplitude of 0.06" for 2 hours in each
	axis.
Mechanical Shock	MIL-STD-883, Method 2002, Test Condition B:
	1500 g, 3 impacts each axis
Solder Heat Resistance and Reflow Condition	Peak temperature 240+/-5 °C for 10 seconds.
	Pre-heat: 150-170 °C for 60 to 90 seconds.
	Peak dwell: over 200 °C for 23 to 26 seconds.
	Handling: Class 1 per MIL-STD-1686
	Reflow Profile is shown at the bottom of this table.
Lead Integrity	MIL-STD 883 Method 2004, Condition D
	8 oz for 30 seconds.
Solderability	MIL-STD-883 Method 2003:
	245 °C +/-5 °C; 95% coverage; no steam aging
Hermeticity	MIL-STD 883 Method 1014:
	Condition A2 and Condition C (no bomb)
ESD Classification	Class I per MIL-STD-883 Method 3015;
	Ensure ESD shielding bag is used during transportation
	processes;
	Personal grounding must be worn at all times when
	handling the device.
Precautions	Do not subject devices to ultrasonic cleaning, which may
1 100000000	cause deterioration and destruction of the device.



ISO 9001 Registered

All specifications are believed to be accurate and reliable. However, Spectrum Microwave reserves the right to make changes without notice.

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